

# High Accuracy Current Sensor IC with 5.0MHz 3dB Bandwidth and Isolation ±5A, ±20A, ±50A, 5V, Ratiometric



# MCR2101-xx-5

### **FEATURES**

- AEC-Q100 qualified
- AMR based integrated current sensor
- Superior Range & Accuracy 0.6% typical total error @25°C (MCR2101-20-5) 2.0% max error over temperature (MCR2101-20-5)
- Superior Frequency Response
  - 5.0 MHz (typical 3dB Magnitude BW)
  - 1.3 MHz (typical 3dB Phase BW)
- Fast output response time (80ns typical)
- Low Primary Resistance (0.9 mΩ)
- Single 5V Supply Operation
- Low power consumption (6.5mA typical)
- Overcurrent fault detection
- SOIC-16 package (RoHS/REACH compliant)
- -40 to +125°C Operating Temperature Range
- UL/IEC/EN62368-1 Certified
  - 4.8 kV Dielectric Strength Voltage 1118 VRMS Basic Isolation Voltage 557 VRMS Reinforced Isolation Voltage

#### **APPLICATIONS**

- Server, Telecom, & Industrial PWR Supplies Power Aggregation, Over-Current Protection Dynamic Current Sensing in Feedback Loops PFC and Inverter Control
- Motor Control Loops & Protection Automation, Robotics, Servo Systems Automotive & EV Power Systems
- Solar Inverters and Optimizers
  - Grid-Tie and Storage Current Monitoring MPPT Circuit Current Monitoring Central Inverter Current Monitoring

#### Consumer

Motor Balance and Remote Device Monitoring Home Automation Control & IOT remote sensing

#### DESCRIPTION

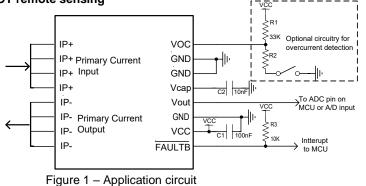
The MCR2101 products are  $\pm 5A$ ,  $\pm 20A$ ,  $\pm 50A$  fully integrated bi-directional analog output current sensors that deliver both high accuracy and high bandwidth. ACEINNA's state-of-the-art Anisotropic Magneto Resistive (AMR) sensor technology provides inherently low noise, excellent linearity and repeatability.

A fully isolated current path is provided by a low resistance copper conductor integrated into the package making it suitable for both high-side and low side bi-directional current sensing. The high bandwidth of 5.0MHz (3Db) and low phase delay makes it ideal for current sense feedback loops in motor control, inverters, uninterruptible power supplies, battery management, power factor correction, high voltage distribution bus converters and power supply applications, including those with fast switching wide-bandgap SiC and GaN based power stages.

These devices are factory-calibrated to achieve low offset error and provide a precise analog voltage output that is linearly proportional to the conduction current (AC or DC) with sensitivity (mV/A) compatible with A/D converters and analog control loops in power systems. The AMR sensor device structure is designed to eliminate sensitivity to stray and common mode magnetic fields.

Due to the inherently low output noise of ACEINNA's sensor technology, additional filtering is not required to reduce noise that reduces accuracy at low-level currents in systems with dynamic load profiles.

The MCR2101 products in SOIC-16 package are simple to use with no or minimal external components (other than decoupling capacitor), supports high isolation and are UL/IEC/EN62368-1 certified.



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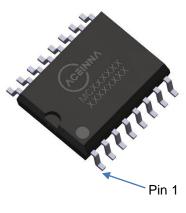
## **ORDERING PART NUMBER**

Ordering Part Number	Part Marking (See Page 12)	Current Range	Gain	VCC (Typical)	Dielectric Strength	Package	Qty per Reel
MCR2101-5-5	MCR21055	±5 Amp	Ratiometric	5.0V	4800V	16 Lead SOIC	1000 pcs
MCR2101-20-5	MCR21205	±20 Amp	Ratiometric	5.0V	4800V	16 Lead SOIC	1000 pcs
MCR2101-50-5	MCR21505	±50 Amp	Ratiometric	5.0V	4800V	16 Lead SOIC	1000 pcs

Note: Evaluation boards are available for each product version (order EVB-MCx2101-xx-x)

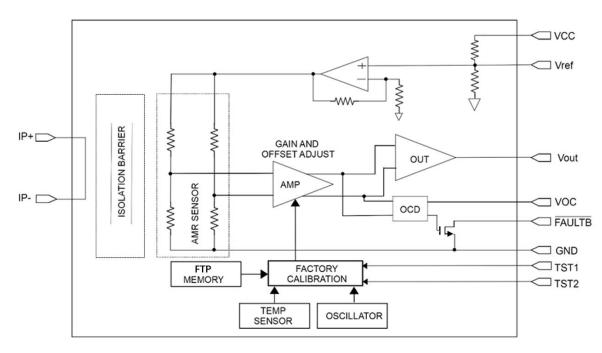
# **PIN DESCRIPTION**

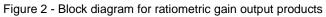
Pin # 16L SOIC	Name	Description
1,2,3,4	IP+	Input of Primary Current Path for Sensing, Fused internally
5,6,7,8	IP-	Output of Primary Current Path for Sensing, Fused internally
9	FAULTB	Overcurrent FAULTB open drain output. Active low.
10	VCC	System Power Supply
11	GND	Recommended to connect to ground
12	Vout	Analog Output Signal linearly proportional to Primary Path Current
13	Vcap	Connect 10nF capacitance to ground
14	GND	Used during initial factory calibration. This pin should be connected to ground or left floating during normal operation.
15	GND	Connect to ground
16	VOC	Input pin. Voltage on this pin defines the overcurrent detection OCD threshold level. Briefly driving this pin to VCC resets and re- arms OCD circuit.



16-pin SOIC

#### **BLOCK DIAGRAM**





# Table 1 – ABSOLUTE MAXIMUM RATINGS

Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation at these or any other conditions beyond those specified is not implied.

Parameters / Test Conditions	Symbol	Value	Unit
Supply Voltage	VCCMAX	-0.5 to 6	V
FAULTB Output Voltage	V FAULTB	-0.5V to VCC+0.5V	V
Sensor Current (IP+, IP-), 5Amp products	IP <sub>MAX</sub>	±10	А
Sensor Current (IP+, IP-), 20Amp products	ІРмах	±50	А
Sensor Current (IP+, IP-), 50Amp products	IP <sub>MAX</sub>	±100	А
Maximum Device Junction Temperature	Тјмах	150	°C
Storage Temperature	T <sub>STG</sub>	-65 to +150	°C
Operating Ambient Temperature Range	TA	-40 to 125	°C
ESD Human Body Model / per ANSI/ESDA/JEDEC JS-001	HBM	8000	V
ESD Charged Device Model / per JEDEC specification JESD22-C101	CDM	2000	V
MSL Rating	MSL	3	
Maximum Soldering Temperature, 10 seconds.	TSOLDER	260	°C

# **Table 2 – ISOLATION CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Value	Unit
Dielectric Strength Test Voltage (Agency type-tested for 60 seconds per UL standard 62368-1 (edition 2). Production tested at 3kVrms per UL 62368-1.	V <sub>ISO</sub>	4800	V
Working Voltage for Basic Isolation. Maximum approved working voltage according to UL 62368-1 (edition 2)- (VPK/DC / VRMS)	V <sub>WVBI</sub>	1582 / 1118	V
Working Voltage for Reinforced Isolation (VPK/DC / VRMS)	Vwvri	788 / 557	V
Clearance distance (Minimum distance through air from IP leads to signal leads)	Dcl	8.0	mm
Creepage distance (Minimum distance along package body from IP leads to signal leads)	D <sub>CR</sub>	8.0	mm

# **Table 3 – THERMAL CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Value	Unit
Junction-to-Ambient Thermal Resistance(Note 1)	$R_{\theta JA}$	27	°C/W
Junction-to-Lead Thermal Resistance	R <sub>θJC</sub>	10	°C/W

Note 1 – The R<sub>0JA</sub> measured on the EB0011- evaluation board with 800mm<sup>2</sup> of 4oz copper on each layer(top and bottom ), thermal vias connecting the layers. The performance values include the power consumed by the PCB.

# Table 4 – ELECTRICAL CHARACTERISTICS COMMON TO ALL VERSIONS

Unless otherwise noted:  $4.5V \le VCC \le 5.5V$ ,  $-40^{\circ}C \le T_A \le 125^{\circ}C$ , I (Vout) = 0 (Recommended Operating Conditions). Typical values are for VCC = 5V and  $T_A = 25^{\circ}C$ .

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Vout Output						
Load Regulation	Vout <sub>LR</sub>	Increase I (Vout) from 0 to -250µA. Measure change in Vout voltage		2	4	mV
Source Current	Vout <sub>SRC</sub>	Vout shorted to GND			50	mA
Sink Current	Vout <sub>SNK</sub>	Vout shorted to VCC			30	mA
Magnitude Frequency Response (-3dB)	Vout <sub>BW</sub>	(Note 2)		5000		kHz
Capacitive Loading	CVout <sub>MAX</sub>	(Note 2)			200	pF
Resistive Loading	RL <sub>MIN</sub>	Minimum load resistance on Vout & Vcap. (Note 2 and Note 3)	10			kohm
Response Time	tresp	$IP_{\pm} = 0$ to +/-100% step input, interval from 80% of the IP to 80% of the Vout. (Note 2)		80		ns
Noise Density	I <sub>ND</sub>	Input Referred, VCC=5V, TA = 25°C, CL=200pF, DC to 100kHz.		35		µA/√Hz
Noise (Input Referred)	Vout <sub>NOISE</sub>	$IP \pm = 0$ , Measure (Vout). DC to 100 kHz. (Note 2)		12		mA (rms)

Note 2 – Guaranteed by design and characterization. Not production tested.

Note 3 - Vcap pin will only support capacitive loads.

# Table 5 – ELECTRICAL CHARACTERISTICS COMMON TO ALL VERSIONS

Unless otherwise noted:  $4.5V \le VCC \le 5.5V$ ,  $-40^{\circ}C \le T_A \le 125^{\circ}C$ , I (Vout) = 0 (Recommended Operating Conditions). Typical values are for VCC = 5V and  $T_A$ = 25°C.

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
VCC Bias Supply						
Supply Voltage	VCC		4.5		5.5	V
Supply Current	IVCC	VCC=5.0 V		6.5	8	mA
Power Up Time	TVCC	Time from VCC > 4.5V to valid Vout and Vcap (Note 2)		0.75	1.25	ms
Primary Side Input						
Primary Conductor		Measure resistance between IP+ and IP- MCR2101-50 Versions (Note 2)		0.9		
Resistance	R <sub>PC</sub>	Measure resistance between IP+ and IP- MCR2101-20, MCR2101-5 Versions (Note 2)		1.3		mΩ

Note 2 – Guaranteed by design and characterization. Not production tested.

Note 3 – Vcap pin will only support capacitive loads.

# Table 6 – PERFORMANCE CHARACTERISTICS- 50A VERSIONS (MCR2101-50-5)

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
NOMINAL Vout TRANSFEI MCR2101-50-5 Vout			1	I		
Input Range	lin	Calibrated Range	-50		+50	А
Sensitivity	GAIN	MCR2101-50-5 (Ratiometric Gain)		40		mV/A
DC ACCURACY						
Zero Current Offset		$I_{IN} = 0$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-240	±80	240	
	IOFFSET	$I_{IN} = 0$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-300	±100	300	mA
0 W W E	_	$I_{IN} = I_{FS}$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-1.9	±0.6	1.9	- %
Sensitivity Error	Es	$I_{IN} = I_{FS}$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-2.4	±0.8	2.4	
	_	$I_{IN} = I_{FS}$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-2.2	±0.7	2.2	%FS
Linearity Error	EL	$I_{IN} = I_{FS}$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-2.2	±0.7	2.2	
		$I_{IN} = \pm 15A \sim \pm 50A$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-2.5	±1.5	2.5	
Total Error	E <sub>TOT</sub>	$I_{IN} = \pm 15A \sim \pm 50A$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-3.6	±1.5	3.6	% RD
LIFETIME DRIFT CHARAC	TERISTICS			•	•	•
Zero Current Offset Drift	IOFFSET(D)	(Note 6)		±380		mA
Sensitivity Drift	E <sub>S(D)</sub>	(Note 6)		±0.4		%
Total Error Drift	Etot(d)	(Note 6)		±1.4		%FS

Note 4: Typ values are  $1\sigma(|mean|+\sigma)$ . Min/max values are guaranteed by production test at  $T_A=25^{\circ}C$  and  $T_A=125^{\circ}C$ . Note 5: Guaranteed by design and characterization. Typ values are  $1\sigma(|mean|+\sigma)$ , min/max values are  $3\sigma(|mean|+/-3\sigma)$ . Note 6: Numbers are based on 3 lots qualification data, taking the shifts from among HTOL (1000 hours). Typical numbers are  $1\sigma(|\text{mean}|+\sigma).$ 

# Table 7 – PERFORMANCE CHARACTERISTICS- 20A VERSIONS (MCR2101-20-5)

Unless otherwise noted: 4.5V < VCC < 5.5V, I(Vout) = 0, Typical values are for VCC = 5V and T<sub>A</sub> = 25°C.

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
NOMINAL Vout TRANSFER MCR2101-20-5, Vout		x 100mV/A x VCC/5V				
Input Range	lin	Calibrated Range	-20		+20	А
Sensitivity	GAIN	MCR2101-20-5 (Ratiometric Gain)		100		mV/A
DC ACCURACY						
Zero Current Offset		$I_{\text{IN}}$ = 0, $T_{\text{A}}$ = 25°C to 125°C (Note 4)	-100	±30	100	
	IOFFSET	$I_{IN} = 0$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-200	±60	200	mA
Sensitivity Error	Es	I <sub>IN</sub> = I <sub>FS</sub> , T <sub>A</sub> = 25°C to 125°C (Note 4)	-1.5	±0.5	1.5	- %
		$I_{IN} = I_{FS}$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-1.5	±0.5	1.5	
Linearth, France	EL	$I_{IN} = I_{FS}$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-1.8	±0.6	1.8	%FS
Linearity Error		$I_{IN} = I_{FS}$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-1.8	±0.6	-1.8	
	_	$I_{IN} = \pm 6A \sim \pm 20A$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-2.0	±0.6	2.0	0/ DD
Total Error	Етот	$I_{IN} = \pm 6A \sim \pm 20A$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-3.0	±1.0	3.0	% RD
LIFETIME DRIFT CHARACT	TERISTICS				•	
Zero Current Offset Drift	I <sub>OFFSET(D)</sub>	(Note 6)		±380		mA
Sensitivity Drift	E <sub>S(D)</sub>	(Note 6)		±0.4		%
Total Error Drift	E <sub>TOT(D)</sub>	(Note 6)		±1.4		%FS

Note 4: Typ values are  $1\sigma(|mean|+\sigma)$ . Min/max values are guaranteed by production test at  $T_A=25^{\circ}C$  and  $T_A=125^{\circ}C$ .

Note 5: Guaranteed by design and characterization. Typ values are  $1\sigma(|mean|+\sigma)$ , min/max values are  $3\sigma(|mean|+/-3\sigma)$ . Note 6: Numbers are based on 3 lots qualification data, taking the shifts from among HTOL (1000 hours). Typical numbers are  $1\sigma(|\text{mean}|+\sigma).$ 

# Table 8 – PERFORMANCE CHARACTERISTICS- 5A VERSIONS (MCR2101-5-5)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
NOMINAL Vout TRANSFE MCR2101-5-5, Vout =			1	1		1
Input Range	I <sub>IN</sub>	Calibrated Range	-5		+5	А
Sensitivity	GAIN	MCR2101-5-5 (Ratiometric Gain)		400		mV/A
DC ACCURACY						
Zero Current Offset		$I_{IN} = 0$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-100	±30	100	
	IOFFSET	$I_{IN} = 0$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-200	±60	200	mA
Sensitivity Error	Es	$I_{IN} = I_{FS}$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-1.5	±0.5	1.5	- %
		$I_{IN} = I_{FS}$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-1.5	±0.5	1.5	
Line anite France	_	$I_{IN} = I_{FS}$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-2.0	±0.6	2.0	
Linearity Error	EL	$I_{IN} = I_{FS}$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-2.0	±0.6	2.0	%FS
	_	$I_{IN} = \pm 3A \sim \pm 5A$ , $T_A = 25^{\circ}C$ to $125^{\circ}C$ (Note 4)	-2.0	±1.0	2.0	04 00
Total Error	E <sub>TOT</sub>	$I_{IN} = \pm 3A \sim \pm 5A$ , $T_A = -40^{\circ}C$ to 25°C (Note 5)	-3.0	±2.0	3.0	% RD
LIFETIME DRIFT CHARAC	TERISTICS		•	•	•	•
Zero Current Offset Drift	IOFFSET(D)	(Note 6)		±380		mA
Sensitivity Drift	Es(D)	(Note 6)		±0.4		%
Total Error Drift	Etot(d)	(Note 6)		±1.4		%FS

Note 4: Typ values are  $1\sigma(|mean|+\sigma)$ . Min/max values are guaranteed by production test at T<sub>A</sub>=25°C and T<sub>A</sub>=125°C. Note 5: Guaranteed by design and characterization. Typ values are  $1\sigma(|mean|+\sigma)$ , min/max values are  $3\sigma(|mean|+/-3\sigma)$ . Note 6: Numbers are based on 3 lots qualification data, taking the shifts from among HTOL (1000 hours). Typical numbers are  $1\sigma(|\text{mean}|+\sigma).$ 

# Table 9 – OCD ELECTRICAL CHARACTERISTICS

Unless otherwise noted: 4.5V < VCC < 5.5V,  $-40^{\circ}C \le T_A \le 125^{\circ}C$ , I(Vout) = 0, Typical values are for VCC = 5V and  $T_A = 25^{\circ}C$ .

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit		
OVERCURRENT FAULT CHARACTERISTICS								
FAULTB Response Time	tresponse	Time from IP > I $\overrightarrow{FAULTB}$ to when $\overrightarrow{FAULTB}$ pin is pulled below V $\overrightarrow{FAULTB}$ ; input current step from 0 to 1.5 xI $\overrightarrow{FAULTB}$		0.2		μs		
FAULTB Range	I FAULTB	For parts rated for IP=5A; VOC voltage between 0 and 0.225*VCC		6		A		
		For parts rated for IP=5A; VOC voltage between 0.225*VCC and 0.35*VCC		7.5				
		For parts rated for IP=5A; VOC voltage between 0.35*VCC and 0.5*VCC		10				
		For parts rated for IP=20A; VOC voltage between 0 and 0.225*VCC		24				
		For parts rated for IP=20A; VOC voltage between 0.225*VCC and 0.5*VCC		30				
		For parts rated for IP=50A; VOC voltage between 0 and 0.5*VCC		60				
FAULTB Output Low Voltage	V FAULTB	In fault condition; $RF_{PU} = 2-10 \text{ k}\Omega$		0.2		V		
FAULTB Output High Voltage	V FAULTB	In fault condition; $RF_{PU} = 2-10 \text{ k}\Omega$			VCC	V		
FAULTB Pull-Up Resistance	RF <sub>PU</sub>		2		10	kΩ		
OCD Threshold Setting Error	E FAULTB			6		%		
VOC Input Range	Vvoc	For setting OCD trig threshold	0		VCC/2	V		
VOC high input level to reset OCD	VIHocd		VCC- 0.5		VCC	V		
VOC High State Duration	THvoc		1			μs		

# AMR TECHNOLOGY

Anisotropic magnetoresistance (AMR) makes use of a common material, Permalloy, to act as a magnetometer. Permalloy is an alloy containing roughly 80% nickel and 20% iron. The alloy's resistance depends on the angle between the magnetization and the direction of current flow. In a magnetic field, magnetization rotates toward the direction of the magnetic field and the rotation angle depends on the external field's magnitude. Permalloy's resistance decreases as the direction of magnetization rotates away from the direction in which current flows, and is lowest when the magnetization is perpendicular to the direction of current flow. The resistance changes roughly as the square of the cosine of the angle between the magnetization and the direction of current flow. Permalloy is deposited on a silicon wafer and patterned as a resistive strip. The film's properties cause it to change resistance in the presence of a magnetic field. In a current sensor application, two of these resistors are connected in a Wheatstone bridge configuration to permit the measurement of the magnitude of the magnetic field produced by the current.

AMR properties are well behaved when the film's magnetic domains are aligned in the same direction. This configuration ensures high sensitivity, good repeatability, and minimal hysteresis. During fabrication, the film is deposited in a strong magnetic field that sets the preferred orientation, or "easy" axis, of the magnetization vector in the Permalloy resistors. AMR has better sensitivity than other methods and reasonably good temperature stability. The AMR sensor has sensitivity which is approximately a linear function of temperature.

#### FUNCTIONAL DESCRIPTION

Figure 2 provide block diagrams of the ratiometric gain. The AMR sensor monitors the magnetic field generated by the current flowing through the U shaped IP+/IP- package lead frame. The AMR sensor produces a voltage proportional to the magnetic field created by the positive or negative current in the IP+/IP- current loop while rejecting external magnetic interference. The sensor voltage is fed into a differential amplifier whose gain is temperature compensated. This is followed by an instrumentation amplifier output stage that provides a voltage that indicates the current passing through the IP+/IP- pins. To provide both positive and negative current data the Vout output pin is referenced to the ground. With no current flowing in the IP+/IP- pins, the voltage on the Vout output will typically equal the voltage of VCC/2. Positive IP+/IPcurrent causes the voltage on Vout to increase relative to VCC/2 while negative IP+/IP- current will cause it to decrease.

#### GAIN

The sensor resistors are biased to the VCC supply voltage and produce a differential voltage that is ratiometric to VCC. This configuration is suited to applications where the A-to-D or other circuitry receiving the current sensor output signals are biased by and ratiometric to the same supply voltage as the current sensor. The ratiometric configuration provides increased gain and resolution compared to fixed gain. The user can also provide a well-regulated 5V supply or monitor the VCC voltage and factor it into the current measurement to take advantage of the ratiometric configuration.

The Vout pin drives to 90% of VCC at full positive current and 10% of VCC at full negative current.

POWER UP / DOWN

An under-voltage lockout circuit monitors the voltage on the VCC pin. If the VCC voltage is less than the under-voltage threshold the MCR2101 is in an inactive state. Vout and Vcap both drive to ground. If the VCC voltage exceeds the under-voltage threshold Vout and Vcap are released and will drive to approximately half the VCC supply voltage and an initial calibration will commence. Once the initial calibration has completed the MCR2101 becomes active. Vout will slew to indicate the value of current flowing in the IP+/- conductor. Current flow in the IP+/- conductor with a VCC voltage less than the under-voltage threshold will not cause damage to the sensor.

# **OVERCURRENT DETECTION (OCD)**

The MCR2101 have fast and accurate overcurrent fault detection circuitry. The overcurrent fault threshold (I FAULTB) is user-configurable via an external resistor divider and supports a range of 120% to 200% of the full-scale primary input (IP). The overcurrent fault threshold (I FAULTB) is set via a resistor divider from VCC to ground on the VOC pin. The voltage on the VOC pin (Vvoc), may range from 0 ×VCC to 0.5 ×VCC.

#### For +/-5A parts

For  $V_{VOC}$  between 0×VCC and 0.225×VCC, the I FAULTB threshold level is 1.2×IP.

For V<sub>VOC</sub> between  $0.225 \times VCC$  and  $0.35 \times VCC$ , the I FAULTB threshold level is  $1.5 \times IP$ .

For  $V_{VOC}$  between 0.35×VCC and 0.5×VCC, the I FAULTB threshold level is 2×IP.

For +/-20A parts

For  $V_{VOC}$  between 0×VCC and 0.225×VCC, the I FAULTE threshold level is 1.2×IP.

For V<sub>VOC</sub> between 0.225×VCC and 0.5×VCC, the I  $_{\rm FAULTB}$  threshold level is 1.5×IP.

#### For +/-50A parts

For V<sub>VOC</sub> between 0×VCC and 0.5×VCC, the I  $_{FAULTB}$  threshold level is 1.2×IP.

If the input current exceeds the OCD threshold value I FAULTB

the output pin FAULTB will transition low and stay low, even if input current drops below the threshold. In order to reset the

FAULTB output, the user needs to bring VOC pin to VCC and hold it there for at least THvoc. Once the OCD function is reset, the VOC voltage should return back to its normal operating voltage Vvoc. A switch SW1 on Figure 1 can be used for this. Other methods are available as well.

If OCD function is used, an OCD reset must be applied to the VOC pin after system power up, to put the OCD function and FAULTB pin in a known state.

The  $\overrightarrow{FAULTB}$  output is active low open drain. A pull-up resistor should be connected between  $\overrightarrow{FAULTB}$  and VCC. The VCC voltage will determine the high level of  $\overrightarrow{FAULTB}$  signal.  $\overrightarrow{FAULTB}$  low output voltage is below 200mV. The value of pull-up resistor is 2-10kOhm.

Phone: 978.965.3200 Fax: 978.965.3201 Document: 6020-2102-01 Rev A E-mail: info@aceinna.com

# FREQUENCY RESPONSE

The MCR2101 offers a low noise and wideband response, with a 3dB magnitude bandwidth of 5.0MHz and 3dB phase bandwidth of 1.3MHz, as shown in the plots below.

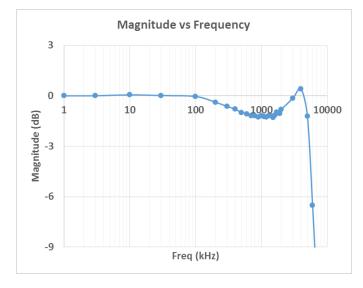


Figure 3 - Magnitude vs Frequency

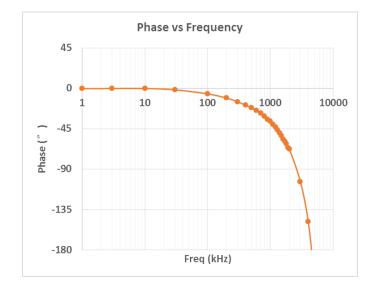


Figure 4 - Phase vs Frequency

#### **RESPONSE TIME**

Vout response time is the time interval from 80% of the IP to 80% of the Vout. This response time is 80ns typical.

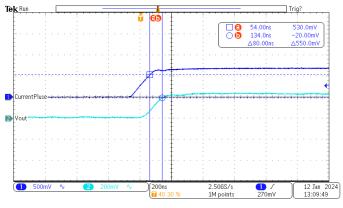


Figure 5 - Vout response time

# **APPLICATIONS INFORMATION**

The MCR2101 detects current by measuring the magnetic field generated by that current. Therefore it's important to consider the effect of externally generated magnetic fields, whether from another current flowing in the system, a magnet, or electromagnetic component.

In order to provide immunity to external fields, MCR2101 senses a differential field generated by the primary current, which flows through a U-shaped conductor inside the package. Therefore, to first order, the sensor will reject any common mode field originating from outside of its package.

However, it's still prudent to minimize the exposure to external fields. The MCR2101 is most sensitive to magnetic fields in the X-Y plane (i.e. the plane of the PCB surface), and is relatively insensitive to fields in the Z direction (perpendicular to the PCB surface). Thus when laying out the PCB, care should be taken to avoid a current passing directly underneath the device itself, because the magnetic field generated by that current will be parallel to the PCB surface.

When laying out the PCB, the traces carrying the input and output currents should approach the two sets of 4 input/output pins in a symmetric manner, from a direction perpendicular to the edge of the package (see Figure 6 below).

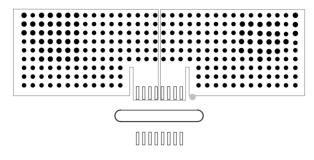


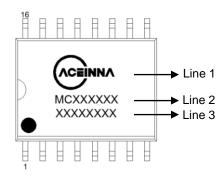
Figure 6 - Layout for current traces

#### Note:

The via break in the metal at either end of the package. The purpose of these is to prevent the input current from approaching the input pins from the lateral direction.

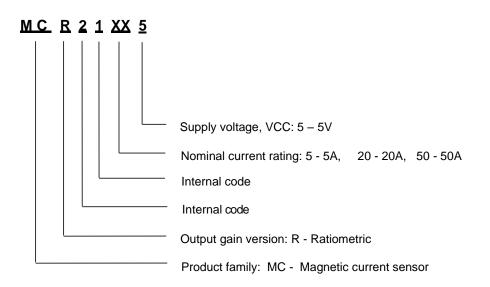
# **DEVICE MARKING**

Production information is printed on the package surface by laser marking. Markings consist of 3 lines of characters including ACEINNA logo.



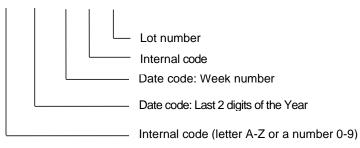
Line 1: ACEINNA Logo Line 2: Part Marking Line 3: Date Code

# PART MARKING (Line 2)

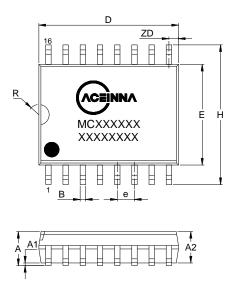


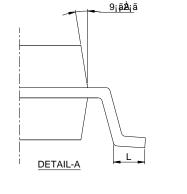
DATE CODE (Line 3)

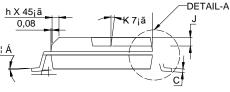




# PACKAGE OUTLINE & RECOMMENDED LAND PATTERN INFORMATION – 16-pin SOIC PACKAGE OUTLINE DRAWING

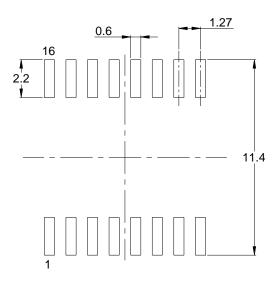






SYMBOL	SOIC-16LD				
	MILLIMETERS				
	MIN	MAX			
А	2.44	2.64			
A1	0.10	0.30			
A2	2.24	2.44			
В	0.36	0.46			
С	0.23	0.32			
D	10.11	10.31			
ш	7.40	7.60			
е	1.27 BSC				
н	10.11	10.51			
h	0.31	0.71			
J	0.381 REF				
К	9° BSC				
L	0.51	1.01			
R	0.76 REF				
ZD	0.66 REF	0.66 REF			
α	0°	8°			

#### RECOMMENDED LAND PATTERN Unit: mm



#### Note:

Recommended land pattern reference IPC7351B; Adjust as necessary to meet application requirements and PCB layout tolerances.

# **RECOMMENDED REFLOW PROFILE**

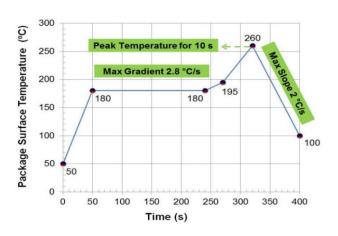


Figure 7- Recommended Reflow Profile

#### Note:

Reflow is limited by 2 times;

The  $2^{nd}$  reflow cycle should be applied after device has cooled down at  $25^{\circ}$ C (room temperature);

The peak temperature is recommended to be in the range of  $235^{\circ}$ C to  $250^{\circ}$ C (not to exceed  $260^{\circ}$ C for 10 seconds);

Use no clean flux to avoid product contaminated by cleaning solvent.